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- ( ) Preliminary Specifications(V ) Final Specifications

Module	13.3"(13.25") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B133XTN01.6 (H/W:2A)
Note ( 🗭 )	LED Backlight with driving circuit design

Customer	Date	Approved by	Date
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Note: This Specification is without notice.	subject to change	NBBU Market AU Optronics	ing Division s corporation

2015/5/6

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# **Record of Revision**

Ve	rsion and Date	Page	Old description	New Description	Remark
0.1	2014/12/17	All	First Edition for Customer		
0.2	2015/3/18	26~27	TBD	Add drawing	
1.0	2015/5/6	All	Final Spec		



### **AU OPTRONICS CORPORATION**

### 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



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### 2. General Description

B133XTN01.6 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

B133XTN01.6 is designed for a display unit of notebook style personal computer and industrial machine.

### 2.1 General Specification

The following items are characteristics summary on the table at 25  $^{\circ}\mathrm{C}$  condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	336.6				
Active Area	[mm]	293.42 x 16	64.97			
Pixels H x V		1366x3(RG	B) x 768			
Pixel Pitch	[mm]	0.2148x0.2148				
Pixel Format		R.G.B. Vertical Stripe				
Display Mode		Normally White				
White Luminance (ILED=22 mA) (Note: ILED is LED current)	[cd/m <sup>2</sup> ]	220 typ. (5 points average) 187 min. (5 points average)				
Luminance Uniformity		1.25 max. (5 points)				
Contrast Ratio		400 typ				
Response Time	[ms]	8 typ / 16 M	lax			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	2.6 max. (Ir	nclude Logic	and Blu po	wer)	
Weight	[Grams]	250 max.				
Physical Size	[mm]		Min.	Тур.	Max.	
Include bracket		Length	305.8	306.3	306.8	
		Width	194.7	195.2	195.7	
		Thickness	-	-	3	
Electrical Interface		eDP 1.2 (1	Lane)			
Glass Thickness	[mm]	0.4				
Surface Treatment		Anti-Glare, Hardness 3H, Reflection 4.3%				
Support Color		262K colors	s(RGB 6-b	it )		



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

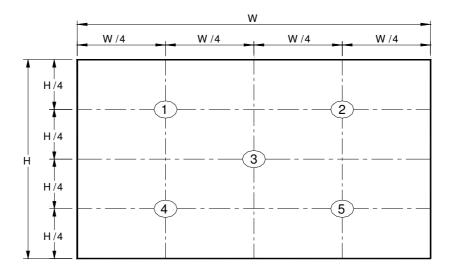
## 2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

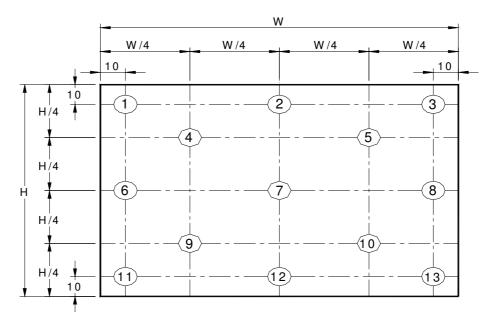
Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Lumir			5 points average	187	220	-	cd/m <sup>2</sup>	1, 4, 5.
Viewing Angle		θ <sub>R</sub> θ <sub>L</sub>	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degree	
		<b>ф</b> н <b>ф</b> ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	- -		4, 9
Luminance Uniformity		δ <sub>5P</sub>	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ <sub>13P</sub>	13 Points	-	-	1.60		2, 3, 4
<b>Contrast Ratio</b>		CR		300	400	_		4, 6
Cross talk		%				4		4, 7
Response <sup>-</sup>	Гime	T <sub>RT</sub>	Rising + Falling	-	8	16	msec	4, 8
	Red	Rx		0.553	0.563	0.593		
	Hed	Ry		0.311	0.341	0.371		
	Green	Gx		0.314	0.344	0.374		
Color / Chromaticity	Green	Gy		0.534	0.564	0.594		
Coodinates	Blue	Bx	CIE 1931	0.131	0.161	0.191		4
	Diue	Ву		0.095	0.125	0.155	-	
	\\/bita	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		

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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



**Note 3**: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

6		Maximum Brightness of five points
δ w5	= '	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
$\delta$ w13	=	Minimum Brightness of thirteen points

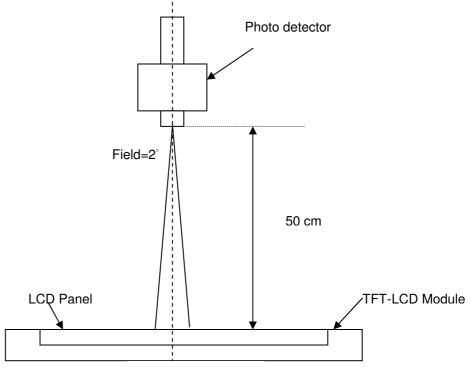
### Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



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Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

**Note 5**: Definition of Average Luminance of White (Y<sub>L</sub>):

Measure the luminance of gray level 63 at 5 points  $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L(x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

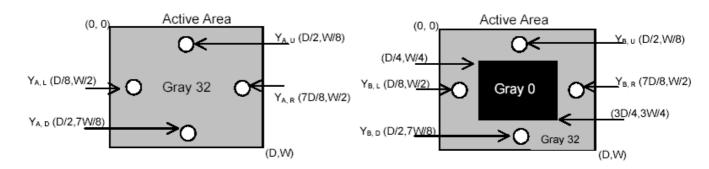
Where

Y<sub>A</sub> = Luminance of measured location without gray level 0 pattern (cd/m<sub>2</sub>)

Y<sub>B</sub> = Luminance of measured location with gray level 0 pattern (cd/m<sub>2</sub>)

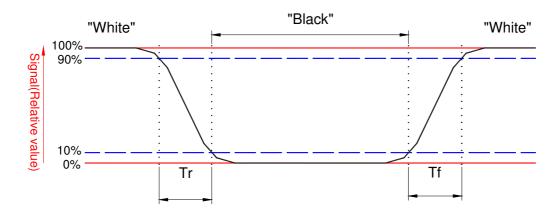


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Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

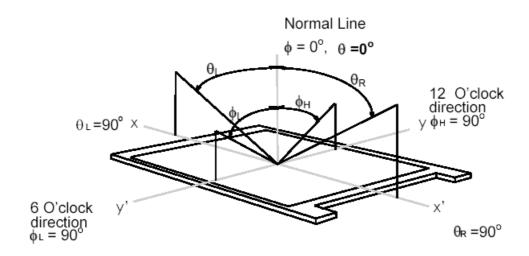




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### Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio  $\geq$  10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° ( $\theta$ ) horizontal left and right and 90° ( $\Phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.

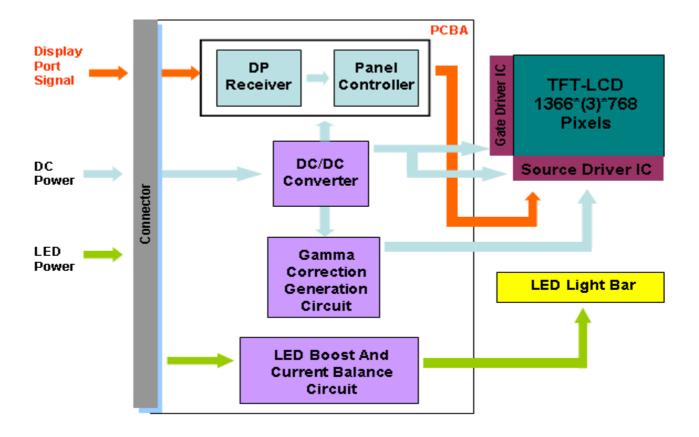




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### 3. Functional Block Diagram

The following diagram shows the functional block of the 13.3 inches wide Color TFT/LCD 30 Pin





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### 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

### 4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

### **4.2 Absolute Ratings of Environment**

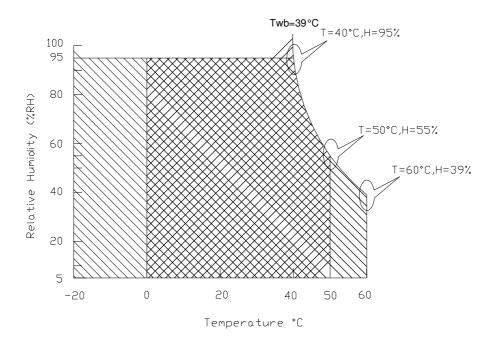
	-9				
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

### 5. Electrical Characteristics

### **5.1 TFT LCD Module**

### 5.1.1 Power Specification

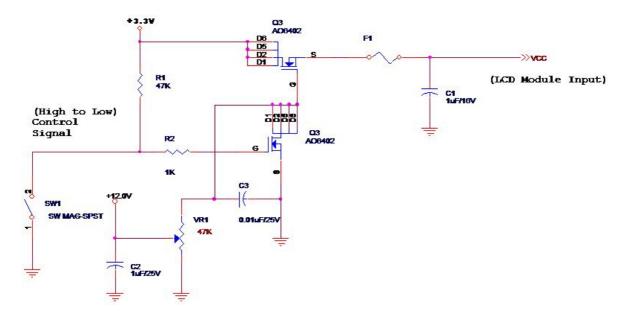
Input power specifications are as follows;

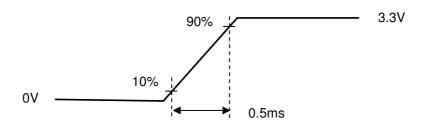
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.75	[Watt]	Note 1
IDD	IDD Current	-	-	227	[mA]	Note 1
lRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (P<sub>max</sub>=V<sub>3.3</sub> x I<sub>black</sub>)

Note 2: Measure Condition





Vin rising time



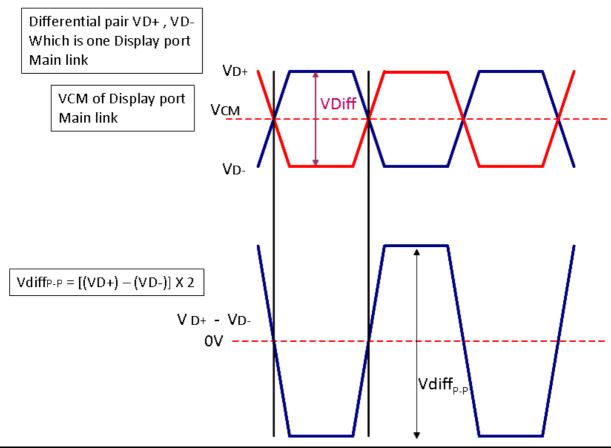
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### **5.1.2 Signal Electrical Characteristics**

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

### Display Port main link signal:



	Display port main link					
		Min	Тур	Max	unit	
VCM	RX input DC Common Mode Voltage		0		V	
VDiff <sub>P-P</sub>	Peak-to-peak Voltage at a receiving Device	100		1320	mV	

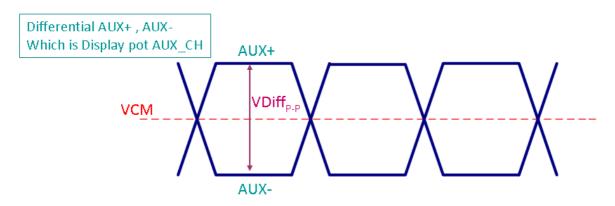
Follow as VESA display port standard

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### **Display Port AUX\_CH signal:**



	Display port AUX_CH								
		Min	Тур	Max	unit				
VCM	AUX DC Common Mode Voltage		0		V				
VDiff <sub>P-P</sub>	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	V				

Follow as VESA display port standard.

### **Display Port VHPD signal:**

	Display port VHPD				
		Min	Тур	Max	unit
VHPD	HPD Voltage	2.25		3.6	V

Follow as VESA display port standard.



## 5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	1.85	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25°C), Note 2
						I <sub>F</sub> =22 mA

Note 1: Calculator value for reference  $P_{LED} = VF$  (Normal Distribution) \* IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

### 5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	5.0	12.0	21.0	[Volt]	
LED Enable Input High Level	· VLED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLLD_LIN	-	-	0.5	[Volt]	Define as
PWM Logic Input High Level	\/D\/\/A	2.5	-	5.5	[Volt]	Connector
PWM Logic Input Low Level	VPWM_EN	-	-	0.5	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	5		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm



## 6. Signal Interface Characteristic

### 6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						13	66
1st Line	R G B	R G B		R	G	В	R	G B
	.	'	•					
			•					
		•	•		•			
			1					
768th Line	R G B	R G B		R	G	В	R	G B



### **6.2 Integration Interface Requirement**

### **6.2.1 Connector Description**

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or Compatible
Type / Part Number	IPEX 20455-030E-12 or Compatible
Mating Housing/Part Number	IPEX 20353-030T-11 or Compatible



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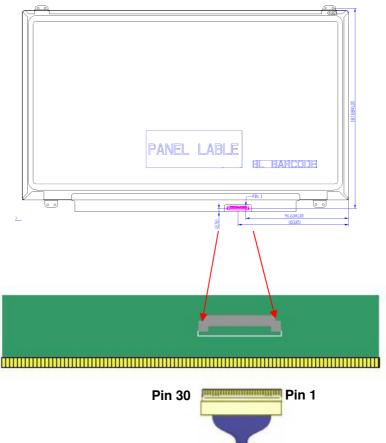
### 6.2.2 Pin Assignment (1 Lane)

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

PIN NO	Symbol	Function
1	DCR_EN	Disable
2	H_GND	High Speed Ground
3	NC	No Connect
4	NC	No Connect
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD GND	LCD logic and driver ground
16	LCD GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight_ground
19	BL_GND	Backlight_ground
20	BL_GND	Backlight_ground
21	BL_GND	Backlight_ground
22	BL_Enable	Backlight On / Off
23	BL PWM DIM	System PWM signal Input
24	NC	Reverse for AUO TEST only
25	NC	Reverse for AUO TEST only
26	BL_PWR	Backlight power (5V~21V)
27	BL_PWR	Backlight power (5V~21V)
28	BL_PWR	Backlight power (5V~21V)
29	BL_PWR	Backlight power (5V~21V)
30	NC	No Connect



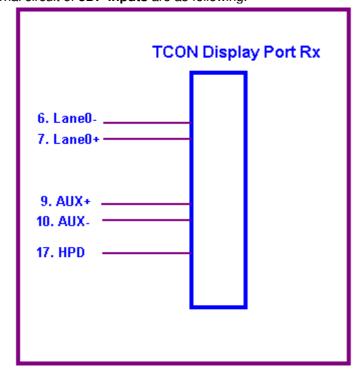
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Connector

**Note1:** Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off. Internal circuit of eDP inputs are as following.





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### **6.3.1 Timing Characteristics**

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T <sub>Clock</sub>	66.9	72	80	MHz
	Period	T <sub>V</sub>	788	824	768+A	
Vertical	Active	T <sub>VD</sub>	768			$T_Line$
Section	Blanking	T <sub>VB</sub>	20	56	Α	
	Period	T <sub>H</sub>	1416	1456	1366+B	
Horizontal Section	Active	<b>T</b> <sub>HD</sub>	1366			$T_{Clock}$
	Blanking	T <sub>HB</sub>	50	90	В	

Note 1: DE mode only

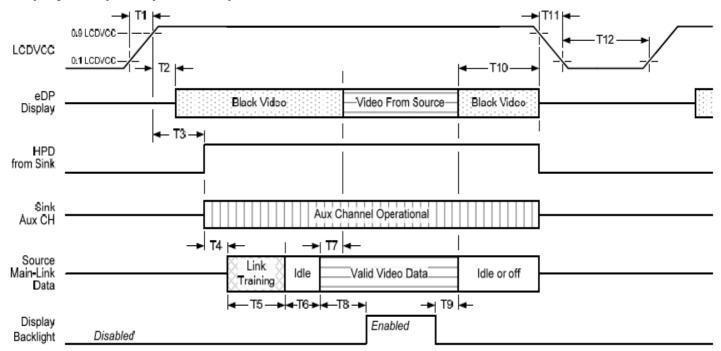
Note 2: The maximum clock frequency = (1366+B)\*(768+A)\*60<80MHz



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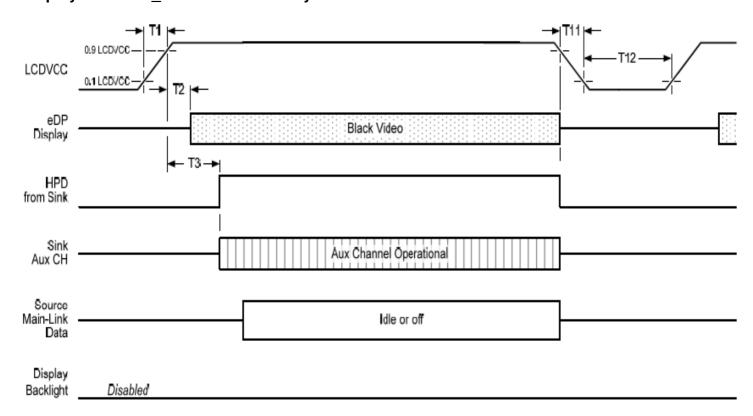
### 6.4 Power ON/OFF Sequence

### **Display Port panel power sequence:**



Display port interface power up/down sequence, normal system operation

### **Display Port AUX\_CH transaction only:**



......

Display port interface power up/down sequence, AUX\_CH transaction only



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### Display Port panel power sequence timing parameter:

Timing	Deparintion	David Inc	Limits			N-4
parameter	Description	Reqd. by	Min.	Тур.	Max.	Notes
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
Т5	link training duration	source				dependant on source link to read training protocol.
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
17	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

**Note1:** The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

-upon LCDVDD power on (with in T2 max)-when the "Novideostream\_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

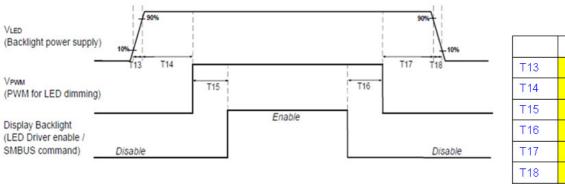
**Note 2:** The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

**Note 3:** The sink must support AUX\_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX\_CH transaction with the time specified within T3 max.

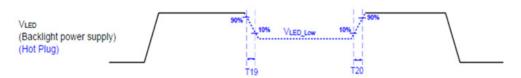


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### Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



......

	Min (ms)	Max (ms)
T13	0.2	10
T14	0	_
T15	0	-
T16	0	=
T17	0	-
T18	0.2	10
T19	1*	2
T20	1*	=

Seamless change: T19/T20 = 5xT<sub>PWM</sub>\*

\*T<sub>PWM</sub>= 1/PWM Frequency

Note 1: If T14,T15,T16,T17<10ms, The display garbage may occur. We suggest T14,T15,T16,T17>10ms to avoid the display garbage.

Note 2: If T13 or T18<0.5ms, the inrush current may cause the damage of fuse. If T13 or T18<0.5ms, the inrush current I2t is under typical melt of fuse Spec., there is no mentioned problem.



### 7. Panel Reliability Test

### 7.1 Vibration Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

### 7.2 Shock Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

### 7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
200	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. Self-recoverable.

No data lost, No hardware failures.

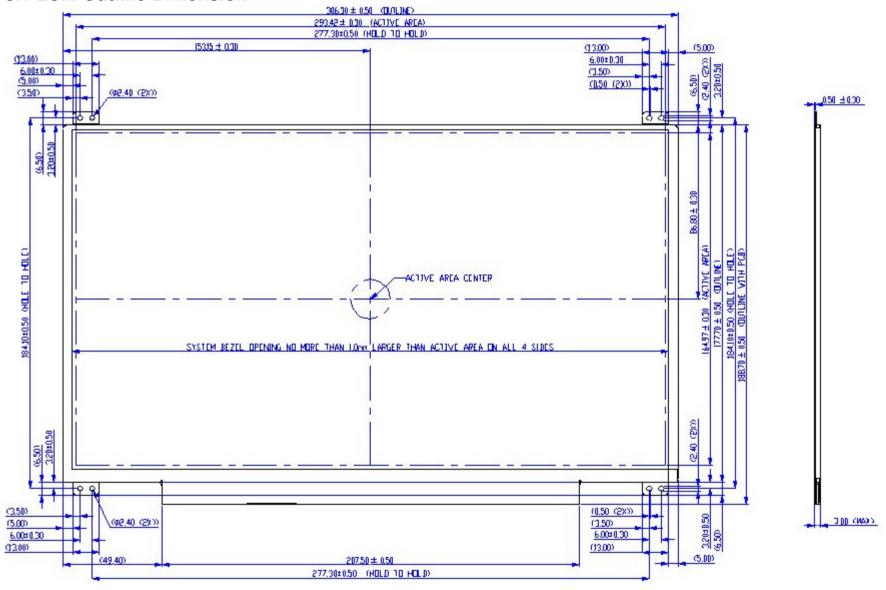
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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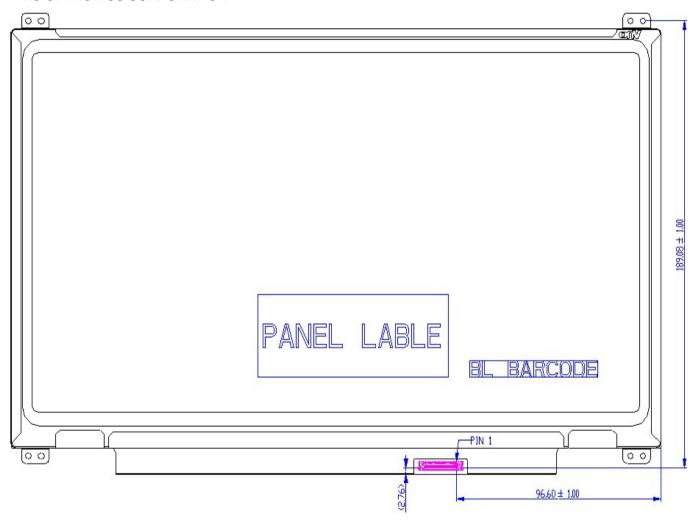
### 8. Mechanical Characteristics

### **8.1 LCM Outline Dimension**





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### 9. Shipping and Package

### 9.1 Shipping Label Format



\*XXXXXXXXXXXXX-ZXXXX\*



B133XTN01.6

Manufactured: MM/WW Model No: B133XTN01.6

AU Optronics Made in China (Z30)









B133XTN01.6

Manufactured: MM/WW Model No: B133XTN01.6

AU Optronics Made in China (Z31)









\*XXXXXXXXXXXXXX-ZXXXXX\*



Manufactured: MM/WW Model No: B133XTN01.6

**AU Optronics** 

Made in China (Z40)



HW: 2A FW:1



\*XXXXXXXXXXXXXX-ZXXXXX\*

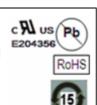


B133XTN01.6

Manufactured: MM/WW Model No: B133XTN01.6

AU Optronics Made in China (Z83)

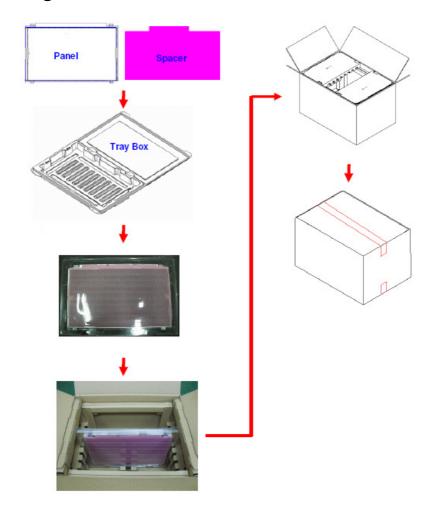
HW: 2A FW:1



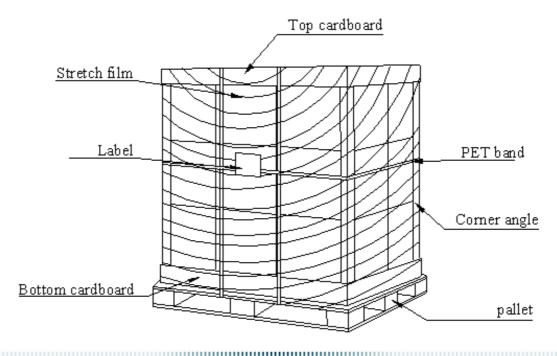


# Product Specification AU OPTRONICS CORPORATION

### 9.2 Carton Package



## 9.3 Shipping Package of Palletizing Sequence





# Product Specification AU OPTRONICS CORPORATION

10 Appendix: FDID Description

Address	FUNCTION	Value	Value	Value
HEX		HEX	BIN	DEC
00	Header	00	00000000	0
01		FF	11111111	255
02		FF	11111111	255
03		FF	11111111	255
04		FF	11111111	255
05		FF	11111111	255
06		FF	11111111	255
07		00	00000000	0
08	EISA Manuf. Code LSB	06	00000110	6
09	Compressed ASCII	AF	10101111	175
0A	Product Code	2C	00101100	44
0B	hex, LSB first	16	00010110	22
0C	32-bit ser #	00	00000000	0
0D		00	00000000	0
0E		00	00000000	0
0F		00	00000000	0
10	Week of manufacture	00	00000000	0
11	Year of manufacture	18	00011000	24
12	EDID Structure Ver.	01	00000001	1
13	EDID revision #	03	00000011	3
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128
15	Max H image size (rounded to cm)	1D	00011101	29
16	Max V image size (rounded to cm)	10	00010000	16
17	Display Gamma (=(gamma*100)-100)	78	01111000	120
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10
19	Red/green low bits (Lower 2:2:2:2 bits)	BB	10111011	187
1A	Blue/white low bits (Lower 2:2:2:2 bits)	F5	11110101	245
1B	Red x (Upper 8 bits)	94	10010100	148
1C	Red y/ highER 8 bits	55	01010101	85
1D	Green x	54	01010100	84
1E	Green y	90	10010000	144
1F	Blue x	27	00100111	39
20	Blue y	23	00100011	35
21	White x	50	01010000	80
22	White y	54	01010100	84
23	Established timing 1	00	00000000	0
24	Established timing 2	00	00000000	0
25	Established timing 3	00	00000000	0
26	Standard timing #1	01	00000001	1
27		01	0000001	1
28	Standard timing #2	01	0000001	1
29		01	0000001	1
	Standard timing #3	01	0000001	1



	AU OF THOMICS CONFORMING	•		
2B		01	0000001	1
2C	Standard timing #4	01	0000001	1
2D		01	00000001	1
2E	Standard timing #5	01	00000001	1
2F		01	0000001	1
30	Standard timing #6	01	0000001	1
31		01	0000001	1
32	Standard timing #7	01	00000001	1
33		01	0000001	1
34	Standard timing #8	01	0000001	1
35		01	0000001	1
36	Pixel Clock/10000 LSB	26	00100110	38
37	Pixel Clock/10000 USB	1B	00011011	27
38	Horz active Lower 8bits	56	01010110	86
39	Horz blanking Lower 8bits	64	01100100	100
3A	HorzAct:HorzBlnk Upper 4:4 bits  Vertical Active Lower 8bits	50	01010000	80
3B	Vertical Active Lower obits  Vertical Blanking Lower 8bits	00	00000000	0
3C	Vertical Blanking Lower obits  Vert Act : Vertical Blanking (upper 4:4 bit)	16	00010110	22
3D	HorzSync. Offset	30	00110000	48
3E 3F	HorzSync. Onset  HorzSync.Width	30	00110000	48
40	VertSync.Offset : VertSync.Width	20 36	00100000 00110110	32 54
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0
42	Horizontal Image Size Lower 8bits	25	00100101	37
43	Vertical Image Size Lower 8bits	A4	10100100	164
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16
45	Horizontal Border (zero for internal LCD)	00	0000000	0
46	Vertical Border (zero for internal LCD)	00	00000000	0
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24
48	Detailed timing/monitor	00	00000000	0
49	descriptor #2	00	00000000	0
4A		00	00000000	0
4B		0F	00001111	15
4C		00	00000000	0
4D		00	00000000	0
4E		00	00000000	0
4F		00	00000000	0
50		00	00000000	0
51		00	00000000	0
52		00	00000000	0
53		00	00000000	0
54		00	00000000	0
55		00	00000000	0
56		00	00000000	0
57		00	00000000	0
58		00	00000000	0
59		20	00100000	32



5A	Detailed timing/monitor	00	00000000	0
5B	descriptor #3	00	00000000	0
5C		00	00000000	0
5D		FE	11111110	254
5E		00	00000000	0
5F	Manufacture	41	01000001	65
60	Manufacture	55	01010101	85
61	Manufacture	4F	01001111	79
62		0A	00001010	10
63		20	00100000	32
64		20	00100000	32
65		20	00100000	32
66		20	00100000	32
67		20	00100000	32
68		20	00100000	32
69		20	00100000	32
6A		20	00100000	32
6B		20	00100000	32
6C	Detailed timing/monitor	00	00000000	0
6D	descriptor #4	00	00000000	0
6E		00	00000000	0
6F		FE	11111110	254
70		00	00000000	0
71	Manufacture P/N	42	01000010	66
72	Manufacture P/N	31	00110001	49
73	Manufacture P/N	33	00110011	51
74	Manufacture P/N	33	00110011	51
75	Manufacture P/N	58	01011000	88
76	Manufacture P/N	54	01010100	84
77	Manufacture P/N	4E	01001110	78
78	Manufacture P/N	30	00110000	48
79	Manufacture P/N	31	00110001	49
7A	Manufacture P/N	2E	00101110	46
7B	Manufacture P/N	36	00110110	54
7C		20	00100000	32
7D		0A	00001010	10
7E	Extension Flag	00	00000000	0
7F	Checksum	45	01000101	69